

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Earlier INRs	ODCs
ex853650900	--Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology) for a voltage not exceeding 1000 volts	5	0	2000	WT/Let			0	
ex853650900	--Electromechanical-snap-action switches for a current not exceeding 11 amps	5	0	2000	WT/Let			0	
853669	-Lamp-holders, plugs and sockets; --Other								
ex853669	---Plugs and sockets for co-axial cables and printed circuits	0	0	1997	WT/Let			0	
853690	-Other apparatus								
ex853690	Wafer probers	20	0	2000				0	
ex853690900	--Connection and contact elements for wires and cables	20	0	2005	WT/Let			0	
8541	Diodes, transistors and similar semiconductor devices; photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes; mounted piezo-electric crystals.								
854110	-Diodes, other than photosensitive or light emitting diodes	0	0	1997	WT/Let			0	
854121	-Transistors, other than photosensitive transistors; --With a dissipation rate of less than 1 W	0	0	1997	WT/Let			0	
854129	--Other	0	0	1997	WT/Let			0	
854130	-Thyristors, diacs and triacs, other than photosensitive devices	0	0	1997	WT/Let			0	
854140	-Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes								

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a	
							GATT Schedule	Earlier INRs ODCs
854140100	--Photo voltaic cells assembled in module or made up into panel	5	0	2000	WT/Let			0
854140900	--Other	0	0	1997	WT/Let			0
854150	-Other semiconductor devices	0	0	1997	WT/Let			0
854160	-Mounted piezo-electric crystals	0	0	1997	WT/Let			0
854190	-Parts	0	0	1997	WT/Let			0
8542	Electronic integrated circuits and microassemblies.							
	-Monolithic digital integrated circuits:							
854212	--Cards incorporating an electronic integrated circuit ("smart" cards)	0	0	1997	WT/Let			0
854213	--Metal oxide semiconductors (MOS technology)	0	0	1997	WT/Let			0
854214	--Circuits obtained by bipolar technology	0	0	1997	WT/Let			0
854219	--Other, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)	0	0	1997	WT/Let			0
854230	-Other monolithic integrated circuits	0	0	1997	WT/Let			0
854240	-Hybrid integrated circuits	0	0	1997	WT/Let			0
854250	-Electronic microassemblies	0	0	1997	WT/Let			0
854290	-Parts	0	0	1997	WT/Let			0
8543	Electrical machines and apparatus, having individual functions, not specified or included elsewhere in this Chapter.							
854311	-Particle accelerators:							
	--Ion implanters for doping semiconductor materials	0	0	1997	WT/Let			0
ex854330	-Other machines and apparatus: Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	10	0	2000	WT/Let			0
854381	--Proximity cards and tags	10	0	2000	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
854389	--Other								
ex854389900	---Electrical machines with translation or dictionary functions	15	0	2000	WT/Let			0	
854390	-Parts								
ex854390	Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	15	0	2000				0	
ex854390900	--Parts of ion implanters for doping semiconductor materials	15	0	2000	WT/Let			0	
8544	Insulated (including enamelled or anodised) wire, cable (including co-axial cable) and other insulated electric conductors, whether or not fitted with connectors; optical fibre cables, made up of individually sheathed fibres, whether or not assembled with electric conductors or fitted with connectors.								
	-Other electric conductors, for a voltage not exceeding 80 V:								
854441	--Fitted with connectors								
ex854441	---Other electric conductors, for a voltage not exceeding 80 V, fitted with connectors, of a kind used for telecommunications	20	0	2005	WT/Let			0	
854449	--Other								
ex854449	---Other electric conductors, for a voltage not exceeding 80 V, not fitted with connectors, of a kind used for telecommunications	20	0	2005	WT/Let			0	
	-Other electric conductors, for a voltage exceeding 80 V but not exceeding 1,000 V:								
854451	--Fitted with connectors								

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a GATT Schedule	Earlier INRs	ODCs
ex854451	---Other electric conductors, for a voltage exceeding 80 V but not exceeding 1000 V, fitted with connectors, of a kind used for telecommunications	20	0	2005	WT/Let				0
854470	-Optical fibre cables	5	0	2005	WT/Let				0
9009	Photo-copying apparatus incorporating an optical system or of the contact type and thermo-copying apparatus.								
	-Electrostatic photo-copying apparatus:								
900911	--Operating by reproducing the original image directly onto the copy (direct process)	15	0	2000	WT/Let				0
	-Other photo-copying apparatus:								
900921	--Incorporating an optical system	15	0	2000	WT/Let				0
900990	-Parts and accessories	15	0	2000	WT/Let				0
9010	Apparatus and equipment for photographic (including cinematographic) laboratories (including apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials), not specified or included elsewhere in this Chapter; negatoscopes; projection screens.								
	-Apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials:								
901041	--Direct write-on-wafer apparatus	15	0	2000	WT/Let				0
901042	--Step and repeat aligners	15	0	2000	WT/Let				0
901049	--Other	15	0	2000	WT/Let				0
901090	-Parts and accessories								
ex901090	--Parts and accessories of the apparatus of Headings No 9010 41 to 9010 49	15	0	2000	WT/Let				0

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a	
							GATT Schedule	Earlier INRs ODCs
ex901110	Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	5	0	2000	WT/Let			0
ex901120	Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	5	0	2000	WT/Let			0
ex901190	Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	0	0	1997	WT/Let			0
ex901190	Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	0	0	1997	WT/Let			0
ex901210	Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	0	0	1997	WT/Let			0
ex901290	Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	0	0	1997	WT/Let			0
ex901720	Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	15	0	2000	WT/Let			0
ex901790	Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	5	0	1997	WT/Let			0

HS96	Description	Base rate	Bound rate	Implementation	Present		Concession first	
					concession established	INR	GATT Schedule	Earlier INRs
ex-901790	Parts of such pattern generating apparatus	5	0	2000	WT/Let			0
9026	Instruments and apparatus for measuring or checking the flow, level, pressure or other variables of liquids or gases (for example, flow meters, level gauges, manometers, heat meters), excluding instruments and apparatus of heading No. 90.14, 90.15, 90.28 or 90.32.							
902610	-For measuring or checking the flow or level of liquids	5	0	2000	WT/Let			0
902620	-For measuring or checking pressure	5	0	2000	WT/Let			0
902680	-Other instruments or apparatus	5	0	2000	WT/Let			0
902690	-Parts and accessories	5	0	2000	WT/Let			0
9027	Instruments and apparatus for physical or chemical analysis (for example, polarimeters, refractometers, spectrometers, gas or smoke analysis apparatus); instruments and apparatus for measuring or checking viscosity, porosity, expansion, surface tension or the like; instruments and apparatus for measuring or checking quantities of heat, sound or light (including exposure meters); microtomes.							
902720	-Chromatographs and electrophoresis instruments	5	0	2000	WT/Let			0
902730	-Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)	5	0	2000	WT/Let			0
902750	-Other instruments and apparatus using optical radiations (UV, visible, IR)	5	0	2000	WT/Let			0
902780	-Other instruments and apparatus	5	0	2000	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
902790	-Microtomes; parts and accessories								
ex902790	--Parts and accessories of products of heading 9027, other than for gas or smoke analysis apparatus and microtomes	5	0	2000	WT/Let				0
9030	Oscilloscopes, spectrum analysers and other instruments and apparatus for measuring or checking electrical quantities, excluding meters of heading No. 90.28; instruments and apparatus for measuring or detecting alpha, beta, gamma, X-ray, cosmic or other ionising radiations.								
903040	-Other instruments and apparatus, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distortion factor meters, psophometers)	5	0	2000	WT/Let				0
903082	-Other instruments and apparatus: --For measuring or checking semiconductor wafers or devices	5	0	2000	WT/Let				0
903090	-Parts and accessories								
ex903090	--Parts and accessories of instruments and apparatus for measuring or checking semiconductor wafers or devices	5	0	2000	WT/Let				0
ex903090	--Parts of instruments and appliances for measuring or checking semiconductor wafers or devices	5	0	2000	WT/Let				0
9031	Measuring or checking instruments, appliances and machines, not specified or included elsewhere in this Chapter; profile projectors.								
	-Other optical instruments and appliances:								

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a GATT Schedule	Earlier INRs	ODCs
903141	--For inspecting semiconductor wafers or devices or for inspecting photomasks or reticles used in manufacturing semiconductor devices	15	0	2000	WT/Let				0
903149	--Other								
ex903149	---Optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	15	0	2000	WT/Let				0
903190	-Parts and accessories								
ex903190	--Parts and accessories of optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices	5	0	2000	WT/Let				0
ex903190	--Parts and accessories of optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	5	0	2000	WT/Let				0

Indonesia

26 March 1997

With respect to any product described in or for Attachment B to the Annex to the Ministerial Declaration on Trade in Information Technology Products (WT/MIN(96)15), to the extent not specifically provided for in this Schedule, the customs duties on such product, as well as any other duties and charges of any kind (within the meaning of Article II:1(b) of the General Agreement on Tariffs and Trade 1994), shall be bound and eliminated, as set forth in paragraph 2(a) of the Annex to the Declaration, wherever the product is classified.

Description

HS

Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	ex. 7017.10
Chemical vapor deposition apparatus for semiconductor production	ex. 8419.89
Parts of chemical vapor deposition apparatus for semiconductor production	ex. 8419.90
Apparatus for stripping or cleaning semiconductor wafers	ex. 8456.91
Laser cutters for cutting contacting tracks in semiconductor production by laser beam	ex. 8456.99
Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	ex. 8464.10
Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	ex. 8466.91
Parts of dicing machines for scribing or scoring semiconductor wafers	ex. 8466.91
Parts of laser cutters for cutting contacting tracks in semiconductor production by laser beam	ex. 8466.93
Parts of apparatus for stripping or cleaning semiconductor wafers	ex. 8466.93
Encapsulation equipment for assembly of semiconductors	ex. 8477.10
Parts of encapsulation equipment	ex. 8477.90
Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	ex. 8479.50
Apparatus for physical deposition by sputtering on semiconductor wafers	ex. 8479.89
Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	ex. 8479.89
Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	ex. 8479.89
Encapsulation equipment for assembly of semiconductors	ex. 8479.89
Machines for bending, folding and straightening semiconductor leads	ex. 8479.89